



Product Change Notification

Change Notification #: 119247-00

Change Title: Select Intel® Optane™ Memory H10 and H20 with Solid State Storage, PCN 119247-00, Product Discontinuance, Product End of Life

Date of Publication: September 08, 2022

Key Characteristics of the Change:

Product Discontinuance

Forecasted Key Milestones:

Last Product Discontinuance Order Date	December 09, 2022
Last Product Discontinuance Shipment Date	March 09, 2023

Description of Change to the Customer:

Intel will be discontinuing the production of the select Intel® Optane™ Memory H10 and H20 with Solid State Storage SKUs found in the Product Affected/Intel Ordering Codes table below.

Customer Impact of Change and Recommended Action:

Please determine your remaining demand for the products listed in the "Products Affected/Intel Ordering Codes" table and place your "Last Product Discontinuance Order" in accordance with the "Key Milestones" listed above. Intel will make commercially reasonable efforts to support last time order quantities for Intel® Optane™ Memory H10 and H20 with Solid State Storage SKUs.

Please contact your local Intel Field Sales representative if you have any further questions about this End of Life notice

Products Affected/Intel Ordering Codes:

Marketing Name	Product Code	Affected MM#
Intel® Optane™ Memory H10 with Solid State Storage (16GB + 256GB, M.2 80mm PCIe 3.0, 3D XPoint™, QLC) Generic Single Pack	HBRPEKNX0101A08	999MJ9
Intel® Optane™ Memory H10 with Solid State Storage (32GB + 512GB, M.2 80mm PCIe 3.0, 3D XPoint™, QLC) Generic Single Pack	HBRPEKNX0202A08	999MJF
Intel® Optane™ Memory H10 with Solid State Storage (32GB + 1TB, M.2 80mm PCIe 3.0, 3D XPoint™, QLC) Generic Single Pack	HBRPEKNX0203A08	999MJG
Intel® Optane™ Memory H10 with Solid State Storage (16GB + 256GB, M.2 80mm PCIe 3.0, 3D XPoint™, QLC) Generic 100 Pack	HBRPEKNX0101A06	999MJH
Intel® Optane™ Memory H10 with Solid State Storage (32GB + 512GB, M.2 80mm PCIe 3.0, 3D XPoint™, QLC) Generic 100 Pack	HBRPEKNX0202A06	999MJJ
Intel® Optane™ Memory H10 with Solid State Storage (32GB + 1TB, M.2 80mm PCIe 3.0, 3D XPoint™, QLC) Generic 100 Pack	HBRPEKNX0203A06	999MJK
Intel® Optane™ Memory H20 with Solid State Storage (32 GB + 512 GB, M.2 80mm PCIe 3.0 3D XPoint™ QLC) Generic Single Pack	HBRPEKNL0202A01	99A263
Intel® Optane™ Memory H20 with Solid State Storage (32 GB + 512 GB, M.2 80mm PCIe 3.0 3D XPoint™ QLC) Generic 100 Pack	HBRPEKNL0202A	99A264
Intel® Optane™ Memory H20 with Solid State Storage (32 GB + 1 TB, M.2 80mm PCIe 3.0 3D XPoint™ QLC) Generic Single Pack	HBRPEKNL0203A01	99A26F
Intel® Optane™ Memory H20 with Solid State Storage (32 GB + 1 TB, M.2 80mm PCIe 3.0 3D XPoint™ QLC) Generic 100 Pack	HBRPEKNL0203A	99A26G

PCN Revision History:

Date of Revision:

September 08, 2022

Revision Number:

00

Reason:

Originally Published PCN



Product Change Notification

119247-00

Notices & Disclaimers

No license (express or implied, by estoppel or otherwise) to any intellectual property rights is granted by this document.

Intel disclaims all express and implied warranties, including without limitation, the implied warranties of merchantability, fitness for a particular purpose, and non-infringement, as well as any warranty arising from course of performance, course of dealing, or usage in trade, except as provided in a separate written agreement.

You may not use or facilitate the use of this document in connection with any infringement or other legal analysis concerning Intel products described herein. You agree to grant Intel a non-exclusive, royalty-free license to any patent claim thereafter drafted which includes the subject matter disclosed herein.

The products described may contain design defects or errors known as errata which may cause the product to deviate from published specifications. Current characterized errata are available on request.

Statements in this document that refer to future plans or expectations are forward-looking statements. These statements are based on current expectations and involve many risks and uncertainties that could cause actual results to differ materially from those expressed or implied in such statements. For more information on the factors that could cause actual results to differ materially, see our most recent earnings release and SEC filings at www.intc.com.

Customer is responsible for safety of the overall system, including compliance with applicable safety-related requirements or standards.

Intel technologies may require enabled hardware, software or service activation.

No product or component can be absolutely secure.

Your costs and results may vary.

©Intel Corporation. Intel, the Intel logo, and other Intel marks are trademarks of Intel Corporation or its subsidiaries. Other names and brands may be claimed as the property of others.

No response from customers will be deemed an acceptance of the change, and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below.

Americas Contact: asmo.pcn@intel.com

Asia Pacific/PRC Contact: apacgccb@intel.com

Europe Email: eccb@intel.com

Japan Email: jccb.ijkk@intel.com